

KA3S0765R

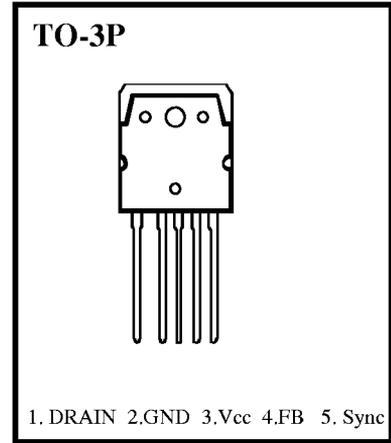
SAMSUNG POWER SWITCH

SAMSUNG POWER SWITCH

The SPS product family is specially designed for an off line SMPS with minimal external component. The SPS consist of high voltage Power SenseFET and current mode control IC. Included control IC features a tr-immered oscillator, under voltage lock out, leading edge blanking, optimized gate driver, and temperature compensated current sources. Also included are various protective functions, thermal shutdown, Over-voltage protection, Overcurrent protection, and overload protection. Compared with RCC or control IC and MOSFET solution, SPS can reduce total number of components, design size, weight. For this reason SPS can increase efficiency, productivity and system reliability. It has a basic platform well suited for cost effective C-TV power supply.

FEATURES

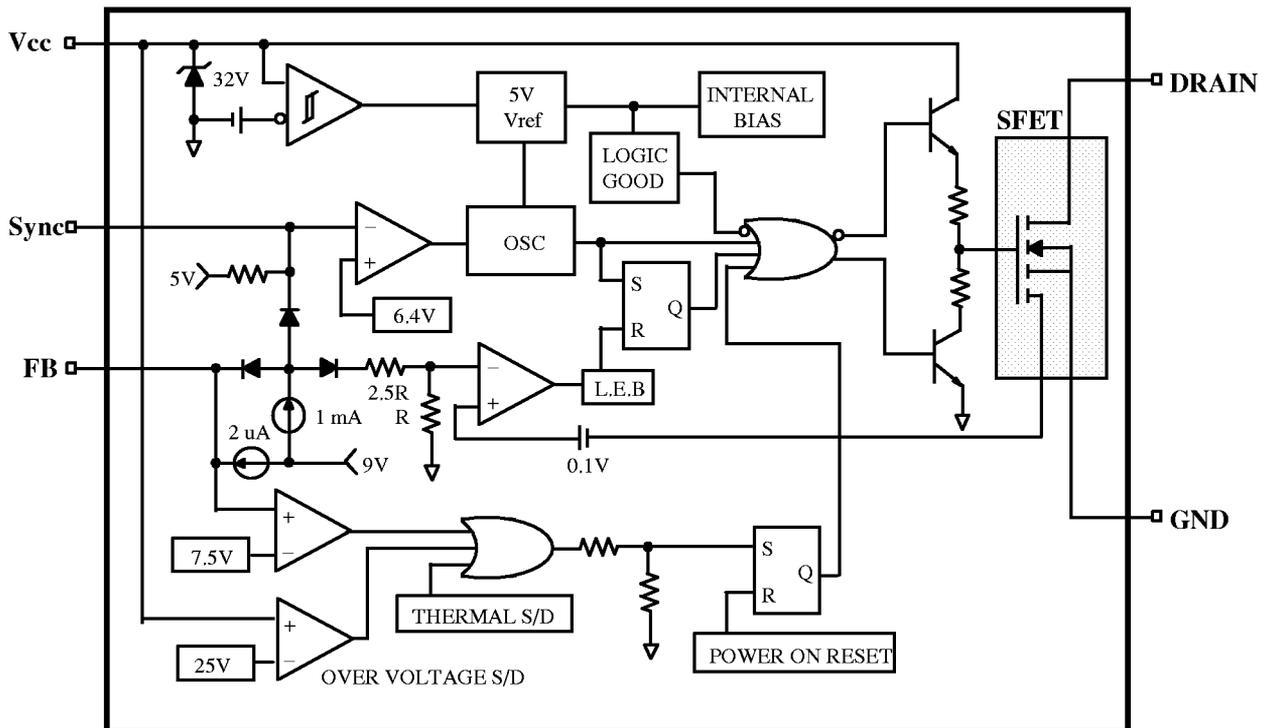
- Wide operating frequency range up to 150KHz
- Pulse by pulse over current limiting
- Over load protection
- Over voltage protection (min:23V)
- Internal thermal shutdown function
- Under voltage lockout
- Internal high voltage sense FET
- External sync terminal
- Auto Restart Mode



ORDERING INFORMATION

| Device | Package | Rating | Topr (i) |
|-----------|---------|----------|------------|
| KA3S0765R | TO3P-5L | 650V, 7A | -20 ~ +80 |

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

| Characteristic | Symbol | Value | Unit |
|---|--------------------------|------------------------|-----------------|
| Drain - Source(GND) Voltage (1) | V _{DSS} | 650 | V |
| Drain - Gate Voltage (R _{GS} = 1M Ω) | V _{DGR} | 650 | V |
| Gate - Source(GND) Voltage | V _{GS} | \leq 30 | V |
| Drain Current Pulsed (2) | I _{DM} | 28.0 | A _{DC} |
| Single Pulsed Avalanche Energy (3) | E _{AS} | 570 | mJ |
| Avalanche Current | I _{AS} | - | A |
| Continuous Drain Current (T _c = 25 \circ C) | I _D | 7.0 | A _{DC} |
| Continuous Drain Current (T _c = 100 \circ C) | I _D | 5.6 | A _{DC} |
| Supply Voltage | V _{CC} | 30 | V |
| Analog Input Voltage Range | V _{FB} | -0.3 ~ V _{SD} | V |
| Total Power Dissipation | P _D (wt H/S) | 140 | W |
| | Derating | 1.11 | W/ \circ C |
| Operating Temperature | T _{OPR} | - 25 ~ + 85 | \circ C |
| Storage Temperature | T _{STG} | - 55 ~ + 150 | \circ C |

Notes: (1) T_J = 25 \circ C to 150 \circ C

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3) L = 24mH, V_{DD} = 50V, R_G = 25 Ω , starting T_j = 25 \circ C

ELECTRICAL CHARACTERISTICS (SFET part)

(T_a = 25 \circ C unless otherwise specified)

| Symbol | Characteristic | Min | Typ | Max | Units | Test Conditions |
|---------------------|--------------------------------------|-----|------|-----|----------|--|
| BV _{DSS} | Drain-Source Breakdown Voltage | 650 | - | - | V | V _{GS} =0V, I _D =50 μ A |
| I _{DSS} | Zero Gate Voltage Drain Current | - | - | 50 | μ A | V _{DS} =Max, Rating, V _{GS} =0V |
| | | - | - | 200 | μ A | V _{DS} =0.8Max, Rating, V _{GS} =0V TC=125 \circ C |
| R _{DS(on)} | Static Drain-Source On Resistance(4) | - | 1.25 | 1.6 | Ω | V _{GS} = 10V, I _D = 4.0A |

ELECTRICAL CHARACTERISTICS (SFET part continued)

(Ta = 25 ; unless otherwise specified)

| Symbol | Characteristic | Min | Typ | Max | Units | Test Conditions |
|------------------|---|-----|------|-----|-------|---|
| gfs | Forward Transconductance(4) | 3.0 | - | - | mho | V _{DS} =15V, I _D =4.0A |
| C _{iss} | Input Capacitance | - | 1600 | - | pF | V _{GS} = 0V, V _{DS} = 25V, f = 1MHz |
| C _{oss} | Output Capacitance | - | 310 | - | | |
| C _{rss} | Reverse Transfer Capacitance | - | 120 | - | | |
| td(on) | Turn On Delay Time | - | 25 | - | nS | V _{DD} = 0.5BV _{DSS} , I _D = 7.0A (MOSFET switching time are essentially independent of operating temperature) |
| tr | Rise Time | - | 55 | - | | |
| td(off) | Turn Off Delay Time | - | 80 | - | | |
| tf | Fall Time | - | 50 | - | | |
| Q _g | Total Gate Charge (Gate-Source + Gate-Drain) | - | - | 72 | nC | V _{GS} = 10V, I _D = 7.0A V _{DS} = 0.5BV _{DSS} (MOSFET switching time are essentially independent of operating temperature) |
| Q _{gs} | Gate-Source Charge | - | 9.3 | - | | |
| Q _{gd} | Gate-Drain(Miller) Charge | - | 29.3 | - | | |

Notes: (1) T_J = 25 ; to 150 ;

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3) L = 24mH, V_{DD} = 50V, R_G = 25 Ω , starting T_J = 25 ;

(4) Pulse Test : Pulse width ; 300uS, Duty Cycle ; 2 %

ELECTRICAL CHARACTERISTICS (Control part)

(Ta = 25 ; unless otherwise specified)

| Symbol | Characteristics | Min | Typ | Max | Unit | Test Conditions |
|--|--|------|------|------|-------|--------------------------------|
| REFERENCE SECTION | | | | | | |
| Vref | Output Voltage (Note 1) | 4.80 | 5.00 | 5.20 | V | Ta = 25 ; |
| Vref/ Δ T | Temperature Stability (Note 1&2) | - | 0.3 | 0.6 | mV/ ; | -25 ; Ta ; +85 ; |
| OSCILLATOR SECTION | | | | | | |
| FOSC | Initial Accuracy | 18 | 20 | 22 | KHz | Ta = 25 ; |
| Δ F / Δ T | Frequency Change with Temperature (Note 2) | | ; 5 | ; 10 | % | -25 ; Ta ; +85 ; |
| VS _{YTH} | Sync Threshold Voltage | 6.0 | 6.4 | 6.8 | V | Vfb = 5 V |
| FEEDBACK SECTION | | | | | | |
| I _{FB} | Feedback Source Current | 0.7 | 0.9 | 1.1 | mA | Ta = 25 ; , Vfb = GND |
| I _{delay} | Shutdown Delay Current | 1.4 | 1.8 | 2.2 | uA | Ta = 25 ; , 5 V ; Vfb ; VSD |
| OVER CURRENT PROTECTION SECTION | | | | | | |
| I _{L(MAX)} | Over Current Protection | 4.4 | 5.00 | 5.6 | A | Max. Inductor Current |
| UVLO SECTION | | | | | | |
| V _{th(H)} | Start Threshold Voltage | 14 | 15 | 16 | V | |
| V _{th(L)} | Minimum Operating Voltage | 9 | 10 | 11 | V | After turn on |

ELECTRICAL CHARACTERISTICS (Continued)

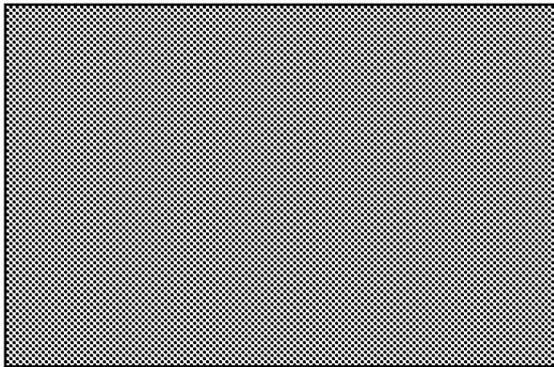
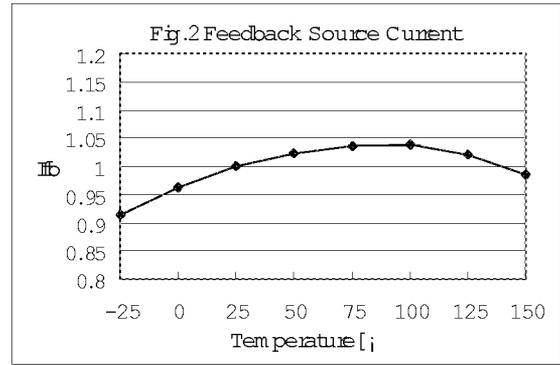
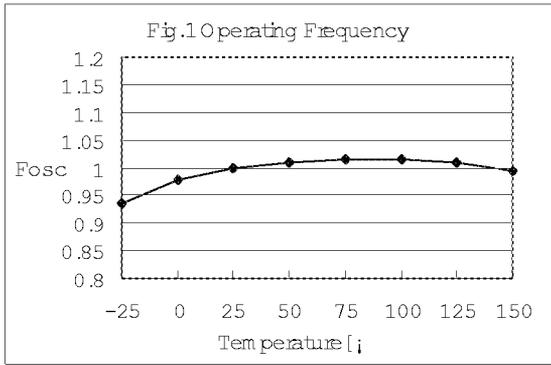
(Ta = 25 ; unless otherwise specified)

| Symbol | Characteristics | Min | Typ | Max | Unit | Test Conditions |
|--------------------------------------|---|-----|------|------|------|------------------------|
| TOTAL STANDBY CURRENT SECTION | | | | | | |
| I _{ST} | Start up Current | 0.1 | 0.3 | 0.55 | mA | V _{CC} = 14V |
| I _{OPR} | Operating Supply Current (control part only) | 6 | 12 | 18 | mA | Ta = 25 ; , |
| V _Z | V _{CC} Zener Voltage | 30 | 32.5 | 35 | V | I _{CC} = 20mA |
| SHUTDOWN SECTION | | | | | | |
| V _{SD} | Shutdown Feedback Voltage | 6.9 | 7.5 | 8.1 | V | |
| T _{SD} | ThermalShutdownTemperature(T _j) | 140 | 160 | - | ; | (Note 1) |
| V _{ovp} | Over Voltage Protection | 23 | 25 | 28 | | |
| SOFT START SECTION | | | | | | |
| I _{SS} | Soft Start Current | 0.8 | 1.0 | 1.2 | mA | Sync&S/S = GND |
| V _{SS} | Soft Start Voltage | 4.7 | 5.0 | 5.3 | V | V _{FB} = 2V |

- Notes:** (1) These parameters, although guaranteed, are not 100% tested in production
(2) These parameters, although guaranteed, are tested in EDS(wafer test) process.
(3) The amplitude of the sync. pulse is recommended to be between 2V and 3V for stable sync. function.

TYPICAL PERORMANCE CHARACTERISTICS

(These characteristic grahps are normalized at $T_a = 25 \text{ } ^\circ\text{C}$)



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(These characteristic graphs are normalized at $T_a = 25 \text{ } ^\circ\text{C}$)



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(These characteristic graphs are normalized at $T_a = 25 \text{ } ^\circ\text{C}$)

